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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/977,124	10/12/2001	Chee-Yee Chung	884.538US1	3114	
21186 7	7590 05/04/2006	EXAMINER			
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.			DINH, TUAN T		
P.O. BOX 293	<del>-</del>	ART UNIT	PAPER NUMBER		
MINNEAPOLIS, MN 55402			2841	THERNOMBER	
			2041		
			DATE MAILED: 05/04/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

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Office Action Summary		Application No.	,	Applicant(s)	
		09/977,124		CHUNG ET AL.	
		Examiner		Art Unit	
		Tuan T. Dinh	į -	2841	
Period fo	The MAILING DATE of this communication apports reply	pears on the cover	sheet with the cor	respondence add	dress
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Status					
2a)□	Responsive to communication(s) filed on <u>02/1.</u> This action is <b>FINAL</b> . 2b) This Since this application is in condition for alloward closed in accordance with the practice under Expression 1.	s action is non-final nce except for fom	nal matters, pros		merits is
Disposit	ion of Claims				
5)□ 6)⋈ 7)□ 8)□ <b>Applicat</b> 9)□ 10)□	Claim(s) 1-10,27-30 and 32-35 is/are pending 4a) Of the above claim(s) 8,9,28 and 29 is/are Claim(s) is/are allowed.  Claim(s) 1-7,10,27,30 and 32-35 is/are rejected Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or ion Papers  The specification is objected to by the Examine The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The Oath Oath Oath Oath Oath Oath Oath Oath	withdrawn from co	nent. ected to by the Ex n abeyance. See 3 drawing(s) is object	37 CFR 1.85(a). cted to. See 37 CF	• •
Priority (	under 35 U.S.C. § 119				
a)	Acknowledgment is made of a claim for foreign All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau See the attached detailed Office action for a list	es have been receives have been receiverity documents have u (PCT Rule 17.2(a	ved. ved in Application ve been received a)).	n No in this National :	Stage
2) Notice (3) Inform	t(s) se of References Cited (PTO-892) se of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) sr No(s)/Mail Date	5) <u>P</u>	nterview Summary (P aper No(s)/Mail Date lotice of Informal Pate ther:	·	-152)

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#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-7, 10-11, 27, and 30-35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nagasaka ('286) in view of Gobbi et al. (U.S. Patent 6,114,930).

As to claims 1-2, 27, Nagasaka discloses a resistive element (12-figures 1-2, column 4, lines 2-3) and an apparatus as shown in figures 1-11, comprising: a resistive material including first and second contact points (13a, 12a, column 4, line 24, see figure 2), the first contact point (13a) having a conductive pattern/land (17) electrically connected to an electrical component (IC chip or chip component, see column 4, lines 30-35), the second contact point (12a) connected to a circuit board plane (a surface of a substrate (11)) using at least one via (15a, column 4, line 26).

Nagasaka disclose the first contact point (13a) having *electrically connected* to IC chips or chip component, see column 4, lines 30-35. The electrical/chip component would be as a capacitor chip component, a decoupling capacitor, or a capacitor.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the electrical or chip component as a passive component or

capacitor as taught by Nagasaka in order to reduce variation in the electrical impedance with frequency of a capacitor mounted on the PCB.

Nagasaka does not teach a summed series resistance provided by adding a value of resistance for the resistive element to an effective series resistance of the capacitor is approximately equal to an effective series resistance of a circuit board and the circuit board plane connected to circuit board.

Gobbi et al. shows an impedance controlled by the phase angle between two signals as shown in figures 2-13 comprising a summed series resistance provided by adding a value of resistance for the resistive element to an effective series resistance of the capacitor is approximately equal to an effective series resistance of a impedance component (5), see column 5, line 39 through column 6, line 21.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have a teaching of Gobbi et al. employed in an apparatus of Nagasaka in order to form an equivalent circuit to control a frequency applied on a circuit board or device.

As to claims 3-6, and 32-35, Nagasaka discloses the resistive material (12) includes first and second metals (column 4, lines 10-11), the first metal is nickel and the second metal is gold, see column 4, lines 30-31.

Claimed variations in relative dimensions, which do not specify a device which performs or operates any differently from the prior art, do not patentably distinguish applicant's invention. <u>Gardner v. TEC Systems, Inc.</u>, 725 F.2d 1338 (Ct. App. Fed. Cir. 1984).

Regarding claim 7, Nagasaka and Gobbi et al. do not specific disclose the particular dimensions of the first and second metals have a width of about 10 to about 1000 microns, a length of about 10 to about 5000 microns, and a total thickness of about 0.05 to about 2.5 microns. However, it would have been obvious to one having ordinary skill in the art at the time of the invention was made to have a dimension of the resistive element in order to reduce sized and thickness for a miniature device, the workable dimensions of the resistive element would have been a matter of routine experimentation. In re Antonie, 559 F.2d 618 (CCPA 1977). Variations in the dimensional of the resistive element would have been obvious minor adjustments without patentable significance. See In re Aller, 105 USPQ 233 (CCPA 1955) (Where general conditions of the claim are disclosed in the prior art, it is not inventive to discover optimal or workable ranges by routine experimentation).

As to claim 10, Nagasaka discloses the second contact point (12a) is connected to the circuit board plane using a plurality of vias (15, column 4, line19).

As to claim 30, Nagasaka discloses an outside surface of the resistive element being attached (by a conductive material filled in the through holes 15).

3. Claims 1-7, 10-11, 27, and 30-35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nagasaka ('286) in view of Novak et al. ('622), and further in view of Gobbi et al. ('930).

As to claims 1-2, 27, Nagasaka discloses a resistive element (12-figures 1-2, column 4, lines 2-3) and an apparatus as shown in figures 1-11, comprising: a resistive

material including first and second contact points (13a, 12a, column 4, line 24, see figure 2), the first contact point (13a) having a conductive pattern/land (17) electrically connected to an electrical component (IC chip or chip component, see column 4, lines 30-35), the second contact point (12a) connected to a circuit board plane (a surface of a substrate (11)) using at least one via (15a, column 4, line 26).

Nagasaka disclose the first contact point (13a) having *electrically connected* to IC chips or chip component, see column 4, lines 30-35. The electrical/chip component would be as a capacitor chip component, a decoupling capacitor, or a capacitor. Further, Novak et al. shows a printed circuit board as shown in figure 24 comprising a capacitor (202) having terminals or leads (210, 212) mounted on and soldered to the surface of the printed circuit board, and a resistive region (250) connected to a first terminal (210) by a solder.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have a teaching of Novak et al. modified the component or chip of Nagasaka in order to reduce variation in the electrical impedance with frequency of a capacitor mounted on the PCB.

Nagasaka does not teach a summed series resistance provided by adding a value of resistance for the resistive element to an effective series resistance of the capacitor is approximately equal to an effective series resistance of a circuit board and the circuit board plane connected to circuit board.

Gobbi et al. shows an impedance controlled by the phase angle between two signals as shown in figures 2-13 comprising a summed series resistance provided by

adding a value of resistance for the resistive element to an effective series resistance of the capacitor is approximately equal to an effective series resistance of a impedance component (5), see column 5, line 39 through column 6, line 21.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have a teaching of Gobbi et al. employed in an apparatus of Nagasaka in order to form an equivalent circuit to control a frequency applied on a circuit board or device.

As to claims 3-6, and 32-35, Nagasaka discloses the resistive material (12) includes first and second metals (column 4, lines 10-11), the first metal is nickel and the second metal is gold, see column 4, lines 30-31.

Claimed variations in relative dimensions, which do not specify a device which performs or operates any differently from the prior art, do not patentably distinguish applicant's invention. Gardner v. TEC Systems, Inc., 725 F.2d 1338 (Ct. App. Fed. Cir. 1984).

Regarding claim 7, Nagasaka, Novak, and Gobbi et al. do not specific disclose the particular dimensions of the first and second metals have a width of about 10 to about 1000 microns, a length of about 10 to about 5000 microns, and a total thickness of about 0.05 to about 2.5 microns. However, it would have been obvious to one having ordinary skill in the art at the time of the invention was made to have a dimension of the resistive element in order to reduce sized and thickness for a miniature device, the workable dimensions of the resistive element would have been a matter of routine experimentation. In re Antonie, 559 F.2d 618 (CCPA 1977). Variations in the

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As to claim 10, Nagasaka discloses the second contact point (12a) is connected to the circuit board plane using a plurality of vias (15, column 4, line19).

As to claim 30, Nagasaka discloses an outside surface of the resistive element being attached (by a conductive material filled in the through holes 15).

## Response to Arguments

4. Applicant's arguments with respect to claims 1-7, 10, 27, 30, and 32-35 have been considered but are moot in view of the new ground(s) of rejection.

### Conclusion

5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Wildi et al. and Kweon et al. disclose related art.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tuan T. Dinh whose telephone number is 571-272-1929. The examiner can normally be reached on M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kammie Cuneo can be reached on 571-272-1957. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Tuan Dinh April 22, 2006..